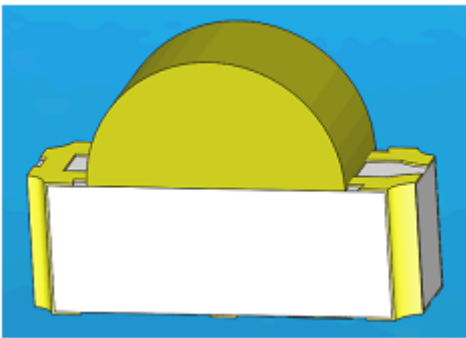


SMD ■ B

12-22/S2ST3D-C30/2C



Features

- Package in 8mm tape on 7" diameter reel.
 - Compatible with automatic placement equipment.
 - Compatible with infrared and vapor phase reflow solder process.
 - Multicolor type.
 - Pb-free.
- .The product itself will remain within RoHS compliant version.
.Compliance with EU REACH.
.Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

- The 12-22 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color
S2S	AlGaInP	Brilliant Orange	Yellow Diffused
T3	InGaN	Pure White	

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	V_R		5	V
Forward Current	I_F	S2S	50	mA
		T3	10	
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	S2S	100	mA
		T3	100	
Power Dissipation	P_d	S2S	120	mW
		T3	40	
Electrostatic Discharge	ESD_{HBM}	S2S	2000	V
		T3	150	
Operating Temperature	T_{opr}		-40 ~ +85	°C
Storage Temperature	T_{stg}		-40 ~ +90	°C
Soldering Temperature	T_{solc}		Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Code	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	S2S	18.0	-----	45.0	mcd	
		T3	45.0	-----	112.0		
Viewing Angle	2θ _{1/2}		-----	130	-----	deg	
Peak Wavelength	λ _p	S2S	-----	611	-----	nm	
		T3	-----	-----	-----		
Dominant Wavelength	λ _d	S2S	600.5	-----	612.5	nm	I _F =5mA
		T3	-----	-----	-----		
Spectrum Radiation Bandwidth	Δλ	S2S	-----	17	-----	nm	
		T3	-----	25	-----		
Forward Voltage	V _F	S2S	1.7	-----	2.3	V	
		T3	2.7	-----	3.3		
Reverse Current	I _R	S2S	-----	-----	10	μA	V _R =5V
		T3	-----	-----	50		

Note:

1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Dominant Wavelength ±1nm
3. RA test @ 5mA
4. Reverse voltage condition is test only. Do not reverse operation.

Bin Range of Luminous Intensity S2S

Bin Code	Min.	Max.	Unit	Condition
M	18.0	28.5	mcd	$I_F = 5\text{mA}$
N	28.5	45.0		

Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
D8	600.5	603.5	nm	$I_F = 5\text{mA}$
D9	603.5	606.5		
D10	606.5	609.5		
D11	609.5	612.5		

Bin Range of Luminous Intensity T3

Bin Code	Min.	Max.	Unit	Condition
P	45.0	72.0	mcd	$I_F = 5\text{mA}$
Q	72.0	112.0		

Note:

1.Tolerance of Luminous Intensity: $\pm 11\%$

2.Tolerance of Dominant Wavelength $\pm 1\text{nm}$

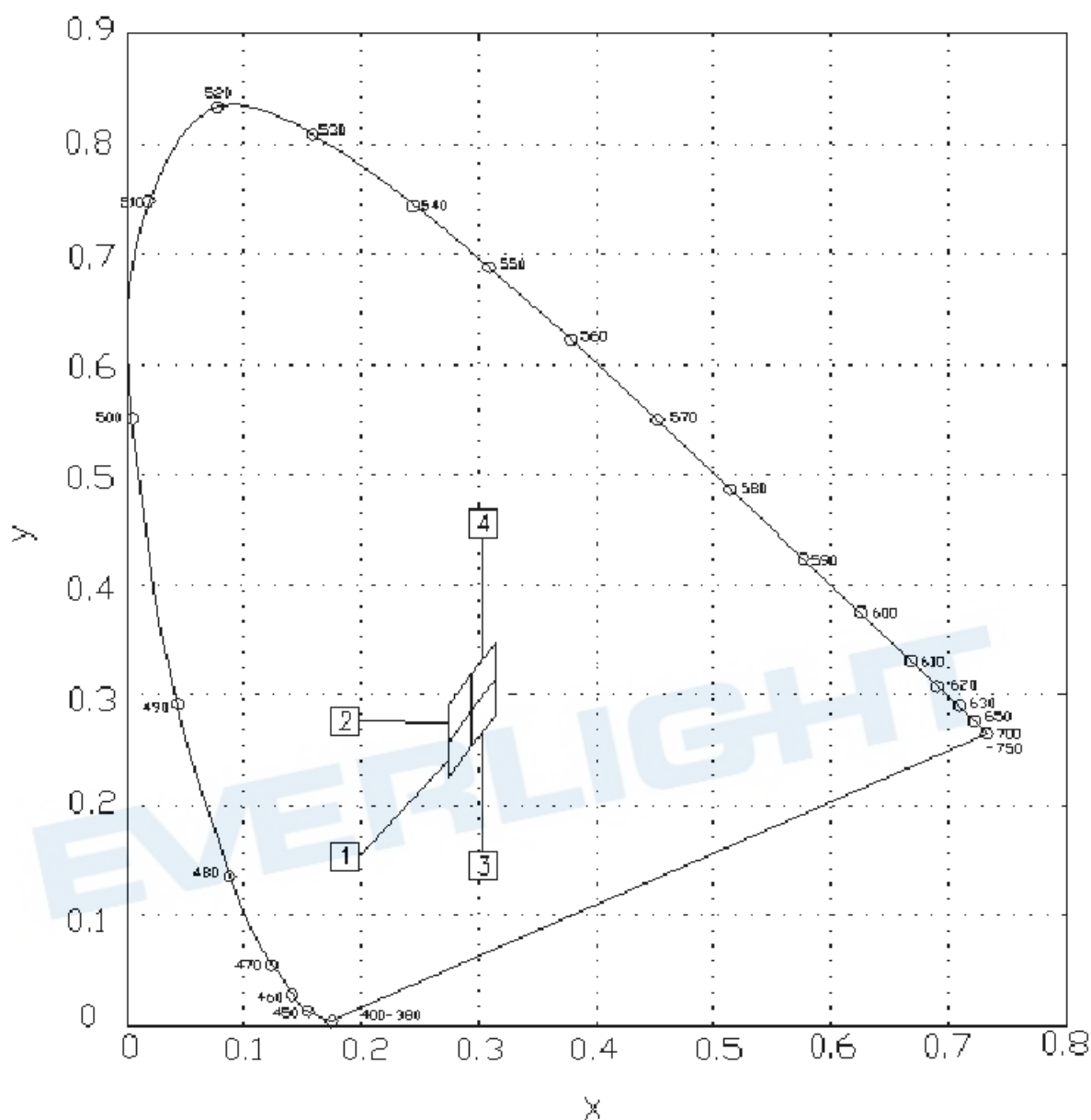
Chromaticity Coordinates Specifications for Bin Greeding
T3

Groups	Bin Code	CIE_x	CIE_y	Condition
C	1	0.274	0.226	I _F =5mA
		0.274	0.258	
		0.294	0.286	
		0.294	0.254	
	2	0.274	0.258	
		0.274	0.291	
		0.294	0.319	
		0.294	0.286	
	3	0.294	0.254	
		0.294	0.286	
		0.314	0.315	
		0.314	0.282	
	4	0.294	0.286	
		0.294	0.319	
		0.314	0.347	
		0.314	0.315	

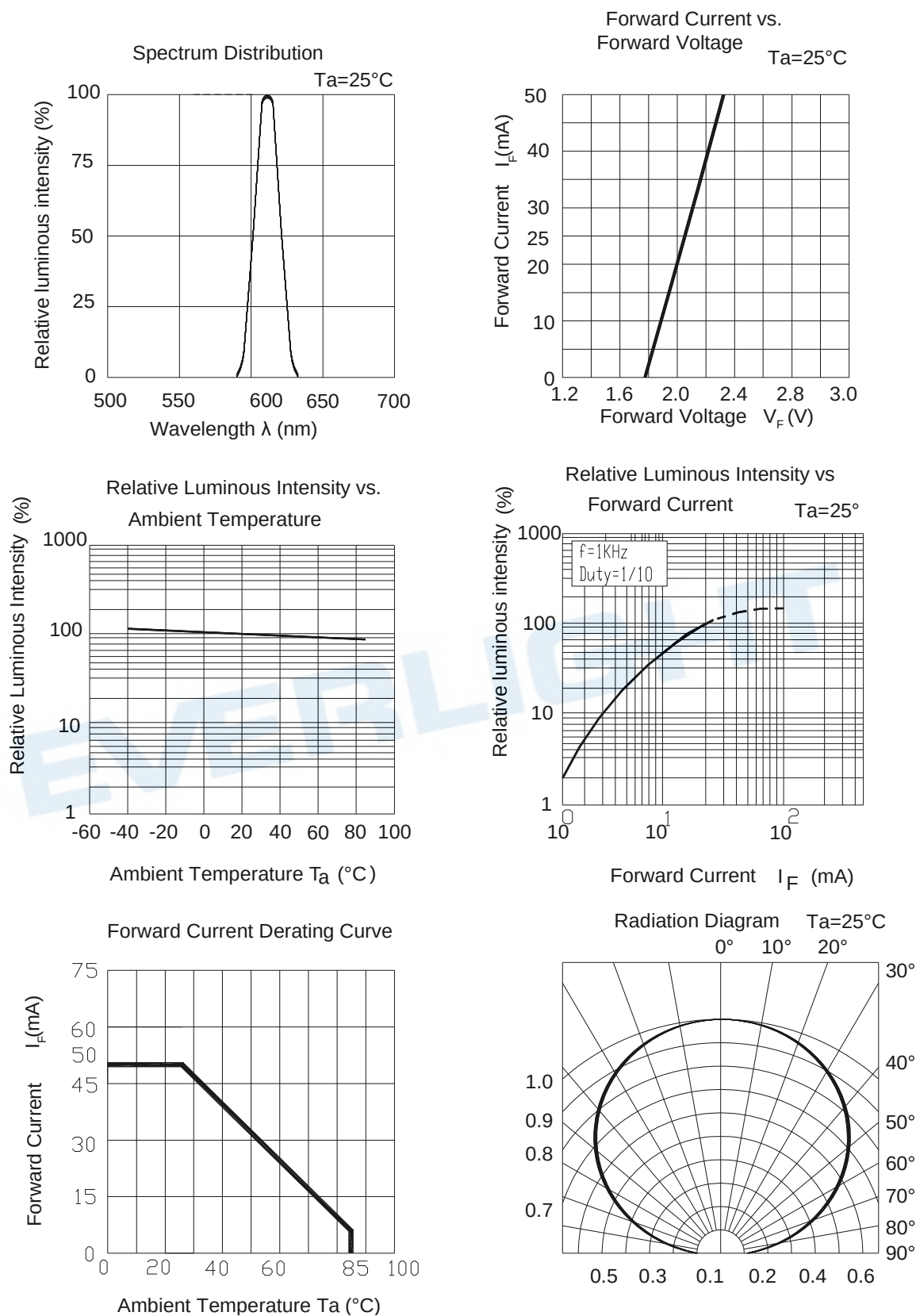
- Notes:
- 1.The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).
 - 2.The products are sensitive to static electricity and care must be fully taken when handling products.

EVERLIGHT

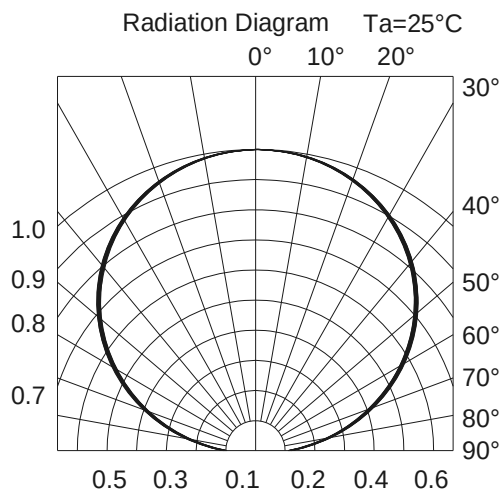
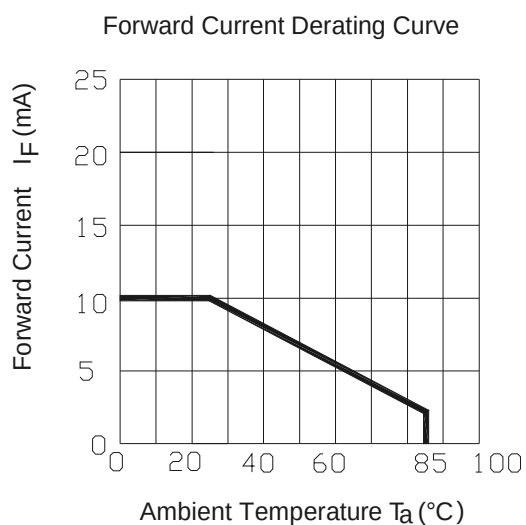
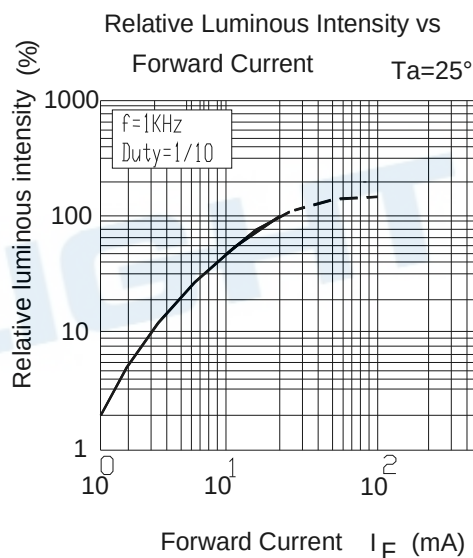
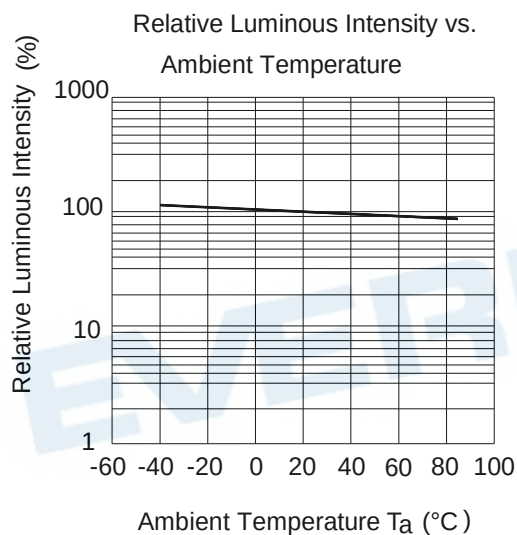
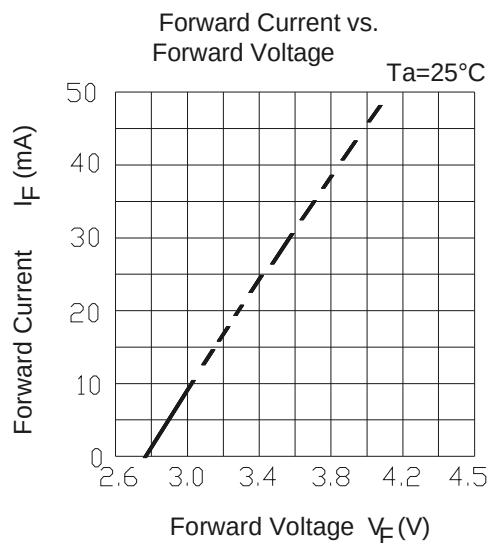
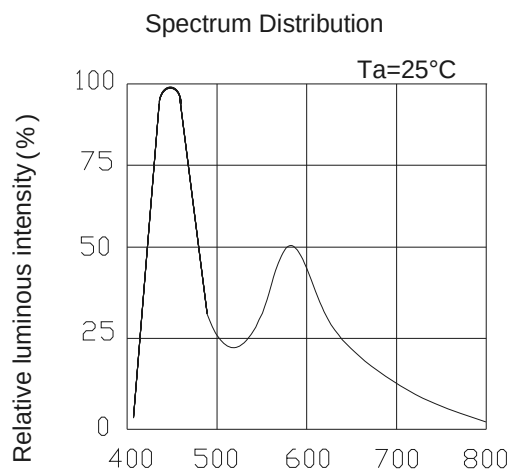
CIE Chromaticity Diagram



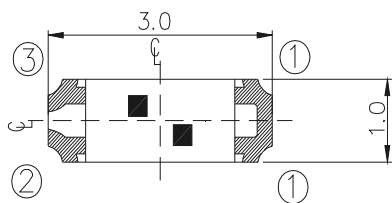
Typical Electro-Optical Characteristics Curves S2S



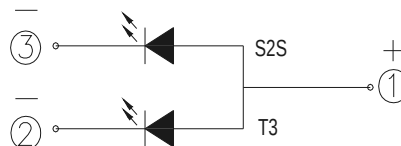
Typical Electro-Optical Characteristics Curves T3



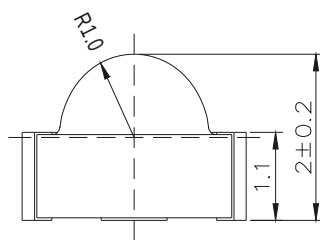
Package Dimension



Top

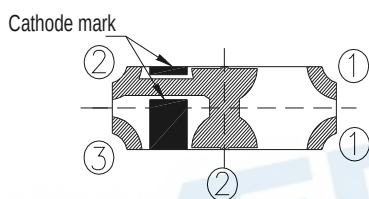


Polarity

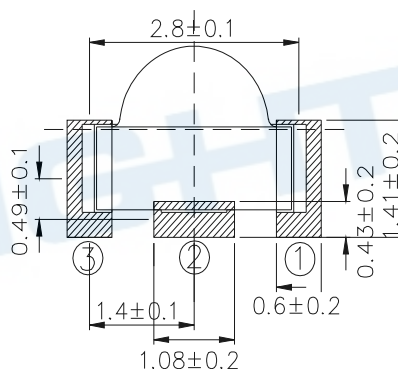


Side

Recommend Soldering Pad



Bottom



Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Materials Label Explanation

RoHS (Pb) EVERLIGHT 5

CPN: XXXXXXXXXXXXXXXXXXXX

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX

P/N: XXXXXXXXXXXX

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX

LOT NO: Y150716XXX-XXXXXXXXXX-XXXXXXXXXX

QTY: 0123456789 HUE: XXXXXXXXXX

CAT: XXXXXXXXXX REF: XXXXXXXXXX

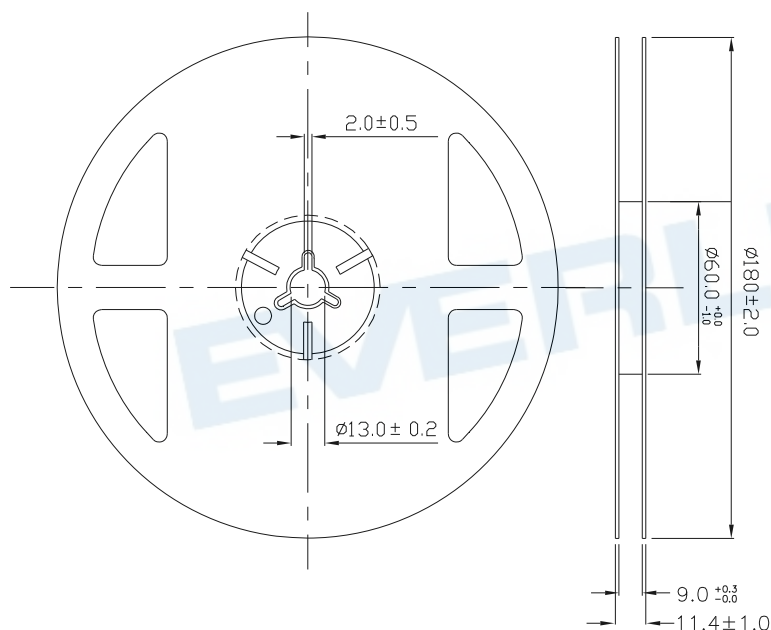
REFERENCE: BTPYMMDDXXXXX

MSL-X MADE IN XXXXXX



- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Progressive direction



Label

Aluminum moisture-proof bag

Desiccant

Label

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 After opening the package: The LEDs should be kept at 30°C or less and 60%RH or less.

2.3 The LEDs should be used within 168 hours (7days) after opening the package.

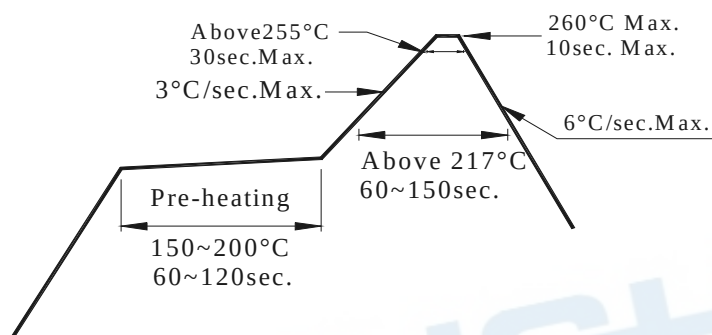
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

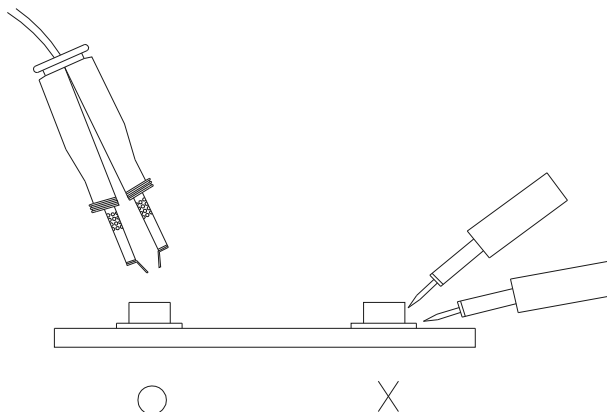
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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